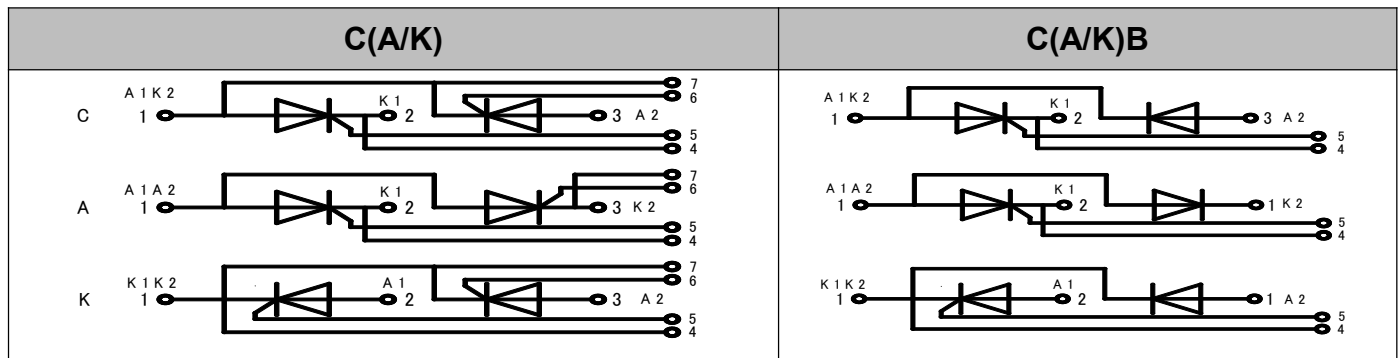


**Applications**

- Power Converters
- Lighting Control
- DC Motor Control and Drives
- Heat and temperature control

Features

- International standard package
- High Surge Capability
- Simple Mounting

Internal Circuit**Blocking - Off State**

TYPE		V _{DRM} /V _{RRM}	V _{DSM} /V _{RSM}	Units
MT330C(A/K)12T3	MT330C(A/K)B12T3	1200	1400	V
MT330C(A/K)14T3	MT330C(A/K)B14T3	1400	1600	V
MT330C(A/K)16T3	MT330C(A/K)B16T3	1600	1700	V

Maximum Ratings

Symbol	Conditions	Values	Units
I _{TAV}	Sine 180°; T _c =85°C	330	A
I _{T(RMS)}		518	A
I _{TSM}	T _{VJ} =130°C t=10ms, sine	9100	A
I ² t	T _{VJ} =130°C t=10ms, sine	414000	A ² s
Visol	a.c.50HZ;r.m.s.;1min,I _{iso} :2mA(MAX)	2500	V
T _{vj}		-40 to 130	°C
T _{stg}		-40 to 125	°C
Mt	To terminals(M8)	12±15%	Nm
Ms	To heatsink(M6)	6±15%	Nm
di/dt	T _{VJ} = T _{VJM} , V _{DM} ≤2/3V _{DRM} , I _{GM} =1.5A t _r ≤0.5μs	100	A/μs
dv/dt	T _{VJ} = T _{VJM} , 2/3V _{DRM} , linear voltage rise	1000	V/μs
Weight	Module(Approximately)	690	g

Thermal Characteristics

Symbol	Conditions	Values	Units
R _{th(j-c)}	per chip	0.097	°C/W
R _{th(c-h)}	per chip	0.04	°C/W



Electrical Characteristics

Symbol	Conditions	Values			Units
		Min.	Typ.	Max.	
V_{TM}	$T=25^{\circ}\text{C}$ $I_{TM}=1000\text{A}$			1.4	V
I_{RRM}/I_{DRM}	$T_{VJ}=T_{VJM}$, $V=V_{RRM}$, $V=V_{DRM}$			80	mA
V_{TO}	$T_{VJ}=T_{VJM}$			0.83	V
r_T	$T_{VJ}=T_{VJM}$			0.5	m Ω
V_{GT}	$T_{VJ}=25^{\circ}\text{C}$, $V_D=12\text{V}$, $R_L=3\ \Omega$	0.8		2.5	V
I_{GT}	$T_{VJ}=25^{\circ}\text{C}$, $V_D=12\text{V}$, $R_L=3\ \Omega$	30		150	mA
I_L	$T_{VJ}=25^{\circ}\text{C}$, $V_D=12\text{V}$, $R_L=3\ \Omega$			1000	mA
I_H	$T_{VJ}=25^{\circ}\text{C}$, $V_D=12\text{V}$, $R_L=3\ \Omega$	20		150	mA
V_{GD}	$T_{VJ}=T_{VJM}$, $V_{DM}=67\%V_{DRM}$	0.2			V

Performance Curves

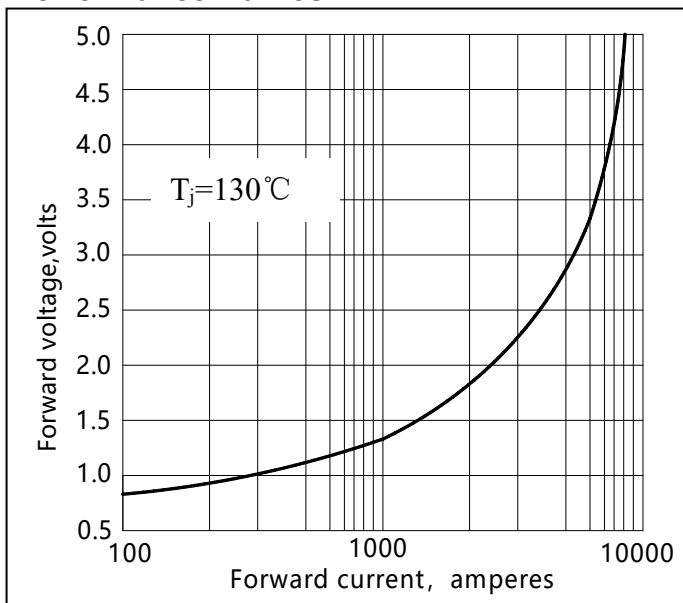


Fig1. Peak On-state Voltage Vs Peak On-state

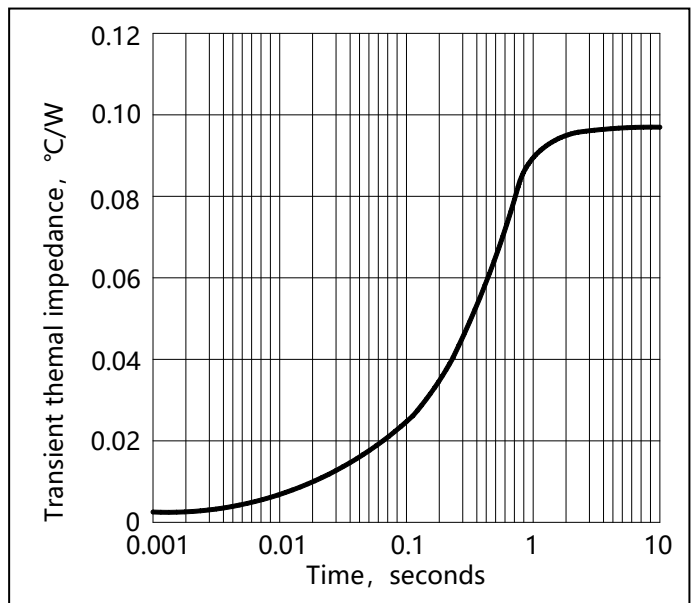


Fig2. Max. junction To case Thermal Impedance Vs Time

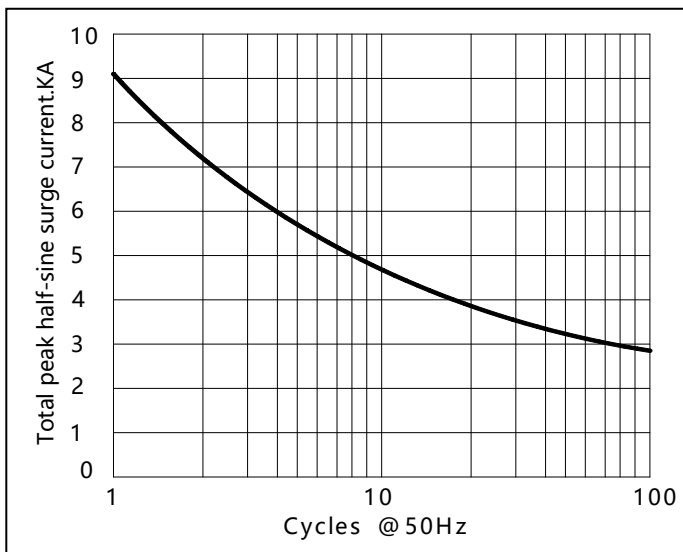


Fig3. Surge Current Vs Cycles

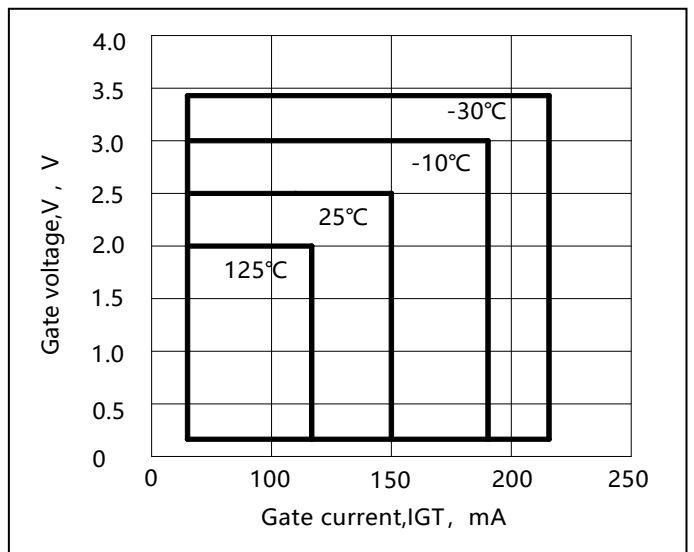


Fig4. Gate Trigger Zone Vs temperature

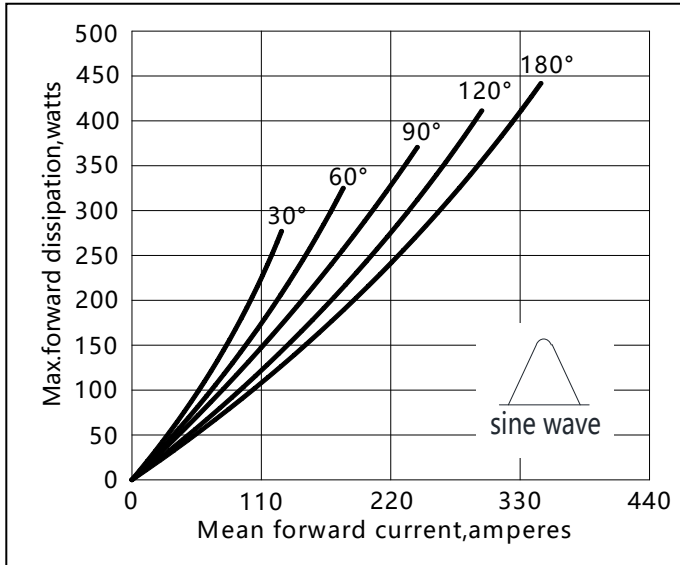


Fig5. Max. Power Dissipation Vs Mean On-state Current

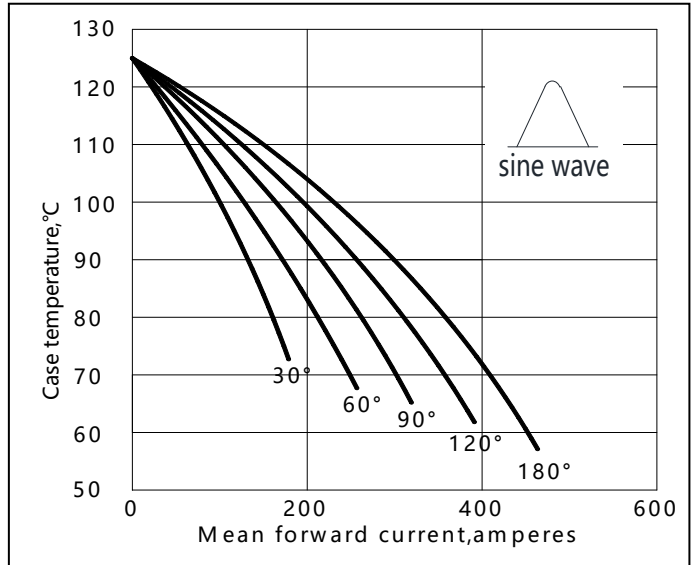
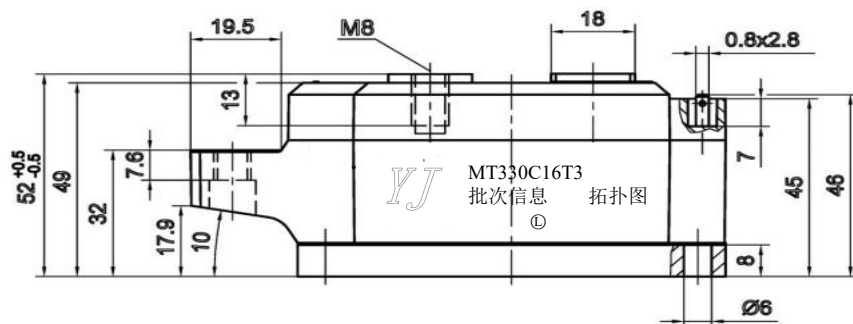


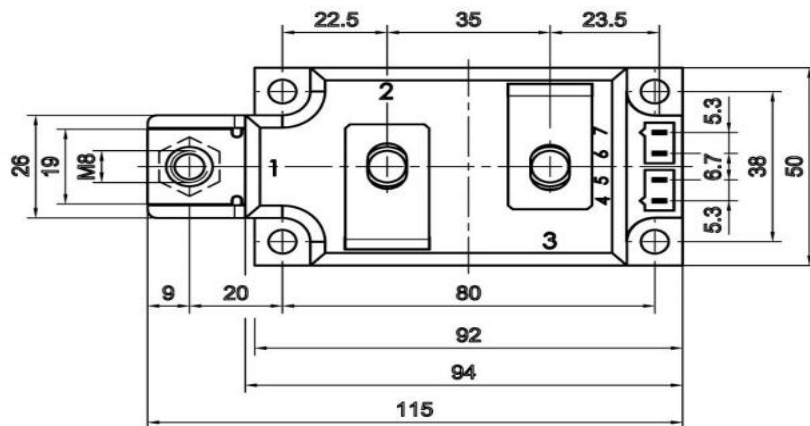
Fig6. Max case Temperature Vs Mean On-state Current

Package Outline Information

CASE:T3



①:低功耗



Dimensions in mm

Unmarked dimensional tolerance: $\pm 0.5\text{mm}$



Disclaimer

The information presented in this document is for reference only. Yangzhou Yangjie Electronic Technology Co., Ltd. reserves the right to make changes without notice for the specification of the products displayed herein to improve reliability, function, or design or otherwise.

The product listed herein is designed to be used with ordinary electronic equipment or devices, and not designed to be used with equipment or devices which require high level of reliability and the malfunction of which would directly endanger human life (such as medical instruments, transportation equipment, aerospace machinery, nuclear-reactor controllers, fuel controllers and other safety devices), Yangjie or anyone on its behalf, assumes no responsibility or liability for any damages resulting from such improper use of sale.

This publication supersedes & replaces all information previously supplied. For additional information, please visit our website <http://www.21yangjie.com> , or consult your nearest Yangjie's sales office for further assistance.